



Manufacturing Capability Expansion & Investment Prioritization (MCEIP) Overview

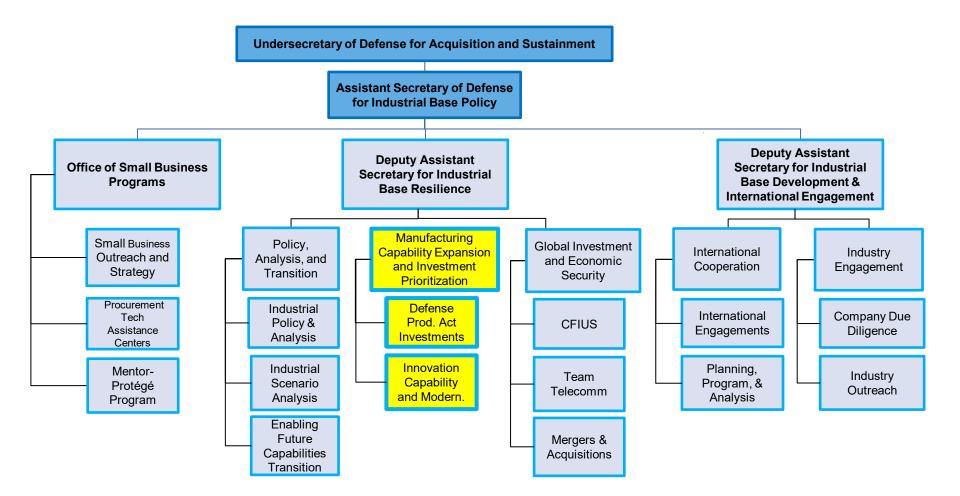


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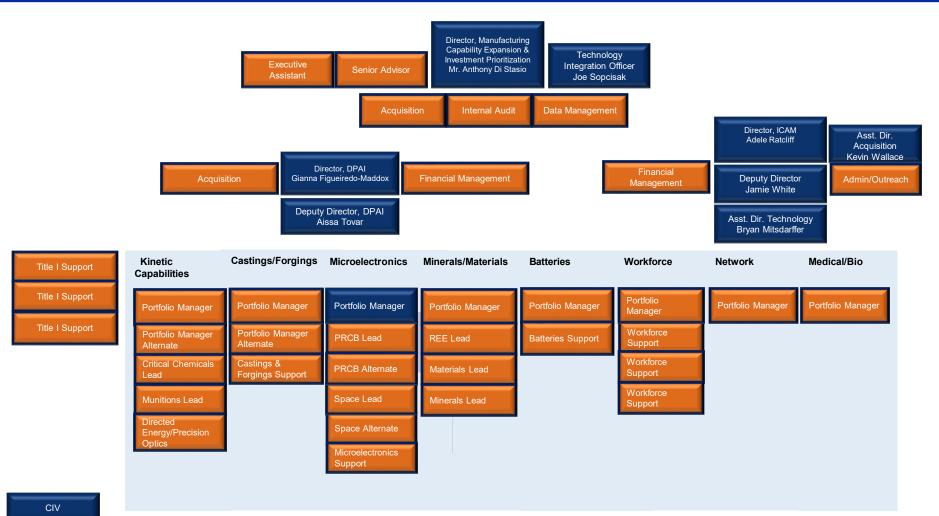
ASD(IBP) coordinates DoD strategy for the defense industrial base (DIB).





MCEIP Organization Chart





СТР





- Incentivizes the creation, expansion and/or preservation of domestic industrial manufacturing capabilities and materials needed to meet national and homeland security requirements
- Manufacturing Capability Expansion and Investment Prioritization (MCEIP) is comprised of two portfolios: Innovation Capability and Modernization (ICAM) and Defense Production Act Investments (DPAI)
 - Together these portfolios provide **complementary** flexible authorities to incentivize and strengthen the Defense Industrial Base
 - The ICAM portfolio oversees the execution of the Industrial Base Analysis and Sustainment (IBAS) authorities
 - IBAS authorities are leveraged to improve the readiness and competitiveness of the domestic industrial base by establishing high-priority domestic capabilities for new supply chains needed for national security and mitigating exposure to global supply chain risks
- The DPAI portfolio oversees the execution of Defense Production Act (DPA) Title I and Title III authorities
 - The purpose of DPA Title I is to ensure the timely availability of industrial resources to meet national defense and emergency preparedness requirements through the Defense Priorities and Allocations System (DPAS)
 - DPA Title III is an investment authority committed to ensuring resilient, robust domestic supply chains in order to reduce reliance on foreign manufacturing and correct domestic shortfalls in the defense industrial base





- The Defense Production Act (DPA) authorizes the President to ensure the availability of U.S. and Canadian industry for U.S. defense, essential civilian, and homeland security requirements.
- The House Committee on Financial Services and the Senate Committee on Banking, Housing, and Urban Affairs have jurisdiction over DPA.

DPA Authorities									
Title I	Title III	Title VII							
Priorities and Allocations	Expansion of Productive Capacity and Supply	General Provisions							
 Prioritize Federal contracts over all other orders Control distribution of scarce materials within the civilian economy Allocate scarce materials against Federal or private contracts Prevent hoarding of scarce materials 	 Incentives to develop, maintain, modernize, and expand production capacity or critical technologies: Loans/ loan guarantees Purchases/ purchase commitments Grants and subsidies 	 Mandatory survey authority of any U.Sregistered business entity Anti-trust immunity for industry, to develop and implement national emergency preparedness plans Committee on Foreign Investment in the U.S. (CFIUS) Civilian Executive Reserve, called into Federal service during a national emergency 							



DPA Title III Authorities and Priority Areas



PE: 0902199D8Z

Authorities								
Loan Guarantees §301 (50 U.S.C. 4531)	Loans §302 (50 U.S.C. 4532)		Purchase Commitments §303 (50 U.S.C. 4533)		Purchases §303 (50 U.S.C. 4533)			
 May be extended when credit is not available to the loan applicant under reasonable terms and conditions sufficient to finance the activity Prospective earning power of the loan applicant and the character and value of the security pledged provide a reasonable assurance of repayment of the loan to be guaranteed 	private the ris marke Projec the loa	e extended when e financing is beyond k of the commercial t eted earnings following an are sufficient to repayment costs	Create a guaranteed demand to reduce risks for industry to make their own investments		 Provide direct subsidies to companies to assist in establishing production capabilities including: Purchase and installation of production equipment in privately owned or Government owned facilities Engineering support to improve quality and yield of production facilities Sample quantities for process validation and customer qualification testing 			
Priority Areas §303 (50 U.S.C. 4533)								
Sustain Critical Production Commercialize				le Emerging Technologies				
"To create, maintain, protect, expand, or restore domestic industrial capabilities essential for National Defense" "from commercial resea to National Defense"		ercial applications" and technologi		creased use of emerging ies in security program applications pid transition of emerging ies"				



Innovation Capability and Modernization (ICAM)



Building the "Next Generation of the Arsenal of Democracy" through execution of the IBAS Program

<u>Mission</u>: Strengthen the competitive posture of the U.S. Defense Industrial Base (DIB) in the era of great powers and global competition

Vision: A modern industrial base that <u>fortifies</u> traditional DIB capabilities and <u>forges</u> emerging sectors to respond <u>at will</u> to national security requirements

Priorities:

- **Prepare the defense industrial workforce** Promote, elevate, and accelerate industrial talent pipelines
- **Ready the modern DIB** Advance and sustain traditional defense manufacturing sectors
- Prepare for the future Identify, attract, and cultivate emerging defense sectors
- Assess and shape the risk Mitigate supply chain vulnerabilities within the global DIB
- Build and strengthen partnerships across the global DIB

Statutorily Based

10 U.S. Code § 4817. Industrial Base Fund – IBAS Authorities

- 1. to support the monitoring and assessment of the industrial base
- 2. to address critical issues in the industrial base relating to urgent operational needs;
- 3. to support efforts to expand the industrial base; and
- 4. to address supply chain vulnerabilities.

These authorities can be used to enhance domestic and allied supply chains.





Awarded Efforts: Obligation (Fully or Partially) Occurred		Planned Efforts: Not Awarded to Date						
Targeted Investment Areas	FY22	FY23	FY24	FY25	FY26	FY27	FY28	
Radiation-Hardened and Strategic Radiation Hardened Microelectronics	\$168.0M - Honeyw \$39.6M - BAE 45/1 \$1.8M - Skywater	vell (FY18 Start I4nm Productio Readout Integr ise Electronics \$1	on & Qualification rated Circuit Four Consortium / Lea 0.0M Copper Solo \$5.0M - Integrat \$15.0M - Infrare \$16.0M - 45nm Si	ard Trusted Mi ndry ad Free der Columns ed Optical Chip d Detectors/Co llicon-on-Insula	croelectronics s/Components mponents	Foundry		
Printed Circuit Boards / Advance Packaging		licon Interpose \$9.847M <mark>\$517</mark>	M - Secure Packa \$156.1M - Adv] Iging	ng	ad-		
DoD Microelectronics Design an Management	d	<mark>\$750K \$1</mark>	00.0M - Enterpris \$735.0M - Mic			tem Digital Eng /	/ Cloud Compute	
Other Microelectronics Projects	\$36.1M - eMagin (Organic Light-I I - Frequency S						

* Reflects FY24 PBR